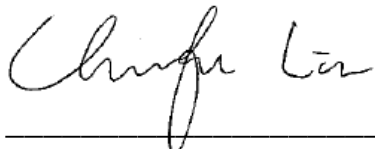
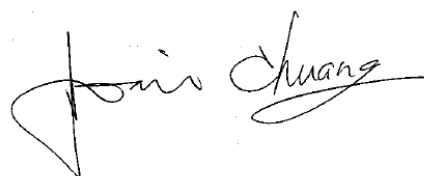


**Harvatek Surface Mount CHIP LEDs Approval Sheet  
Model No.: HT-110NB**

**Acknowledged by**



**Section Manager  
Production Engineering Dept.**



**Manager  
Production Engineering Dept.**

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Tentative Product	*****	*****		HDS-110-K203
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## Introduction

- *The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by HARVATEK for any infringements of intellectual property or other rights of the third parties which may result from it use.*
- *Harvatek is continually effort to improve the quality of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing HARVATEK products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such HARATEK products cause loss of human life, bodily injury or damage to property.*
- *The HARVATEK products listed in this document are intended for usage in general electronics (computer, personal equipment, office equipment, industrial robotics, domestic, etc...) These products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury.*
- *In developing your designs, please ensure that HARVATEK products are used within specified operating ranges as set forth in the most recent HARVATEK products specifications.*
- *Also, please keep in mind the precautions listed in this document.*

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## Product Specification

	Specification	Material	Quantity
Iv	45-112.5mcd @20mA/ Ta= 25° C Tolerance: ± 10%		
lambda(λ <sub>D</sub> )	468 ~ 480 nm @20mA/ Ta= 25° C Tolerance: ± 0.5nm		
Vf	2.7~3.7V @20mA/ Ta= 25° C		
Ir	< 20 μA @ V <sub>R</sub> = 5 V		
Resin	Water Clear	Epoxy resin	
Carrier tape	According to EIA 481-1A specs	Conductive black tape	3000pcs per reel
Reel	According to EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel one bag
Carton	HT standard	Paper	Non-specified

Others:

Every mid-box will be loaded 5 reels. These 5 reels can be different in lot, Iv, lambda, or Vf. Every reel will have an independent label to identify its specification and the mid-box there will have a corresponding label post on it.

### ATTENTION: Electricstatic Discharge (ESD) protection




The symbol shown on the page herein to introduce 'Electro-Optical Characteristics'. ESD protection for GaP and AlGaAs based chips is still necessary even though they are safe in low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD protection has to be considered and taken in the initial design stage.

If manual work/process is needed, please ensure the device is well protected from ESD during all the process.

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## Label Spec.:

<b>HARVATEK</b>			Date: yyyy/mm/dd 
CUSTOMER P/N: 			
HARVATEK P/N: 		QTY: PCS 	
LOT NO: 		QC	
IV BIN:	COLOR BIN:	VF:	

### ■ Customer P/N: To Be Defined

### ■ Harvatek P/N

**H T - 1 1 0 NB**

Series Name	Emitting Color
HT-110: 3.2x1.5x1.0mm	NB: InGaN Blue@20mA

### ■ Lot No.

1 2 3 4 5 6 7 8 9 10  
**P 1 2 2 3 0 A - C T**

Code 1	Code 2	Code 3	Code 4, 5	Code 6, 7	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Lots	Resin Color	Packaging
Internal Tracing Code	Z: 2000 1: 2001 2: 2002 3: 2003 .....	1: Jan. 2: Feb. .... 9: Sep. A: Oct. B: Nov. C: Dec.	1~31/ (30)	01~99, A,B,C...	C: Water Clear	T: Taped Reel

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■ Iv Bin:

Color	Bin Code	Spec. Range
Blue	P1	45-56mcd
	P2	56-72mcd
	Q1	72-90mcd
	Q2	90-112.5mcd

■ Color Bin:

Color	Bin Code	Spec. Range
Blue	C	468-472nm
	D	472-476nm
	E	476-480nm

■ Vf Bin:

Color	Bin Code	Spec. Range
Blue	G8	2.7-2.9V
	H7	2.9-3.1V
	H8	3.1-3.3V
	J7	3.3-3.5V
	J8	3.5-3.7V

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## Product Feature

### Electro-Optical Characteristics

( $I_F$  @ 20mA,  $T_a$  25°C)

Code for parts	Lighting Color	Material	$V_F$ (V)		$\lambda$ (nm)			$I_V^*$ (mcd)
			typ	max	$\lambda_D$	$\lambda_P$	$\Delta \lambda$	Typ
HT-110NB	Blue	InGaN	3.3	3.7	470	468	40	72

### Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

Unit: mm Tolerance: +/-0.1

Outline Dim.	Soldering Pattern
Soldering terminal may shift in x, y direction.	

### Absolute Maximum Ratings

( $T_a$  25°C)

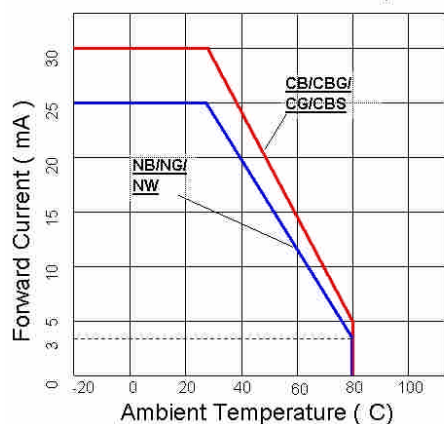
Series	$P_d$ (mW)	$I_F$ (mA)	$I_{FP}$ (mA)	$V_R$ (V)	$I_R$ (uA)	$T_{OP}$ (°C)	$T_{ST}$ (°C)
HT-110NB	74	20	80**	5	<100@ $V_R = 5$	-30~+80	-40~+85

\*\* Condition for  $I_{FP}$  is pulse of 1/10 duty and 0.1msec width

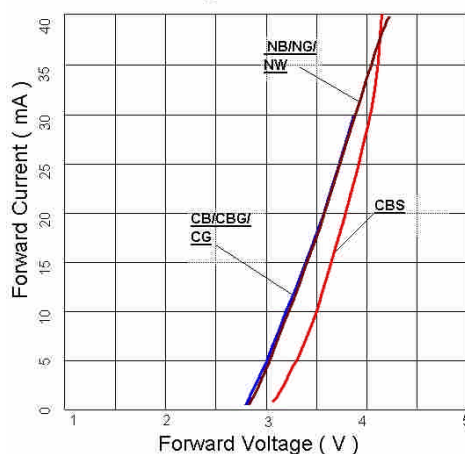
Official Product	HT Part No. HT-110NB	Your Part No.		Data Sheet No.
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### Characteristics of HT-110 Series

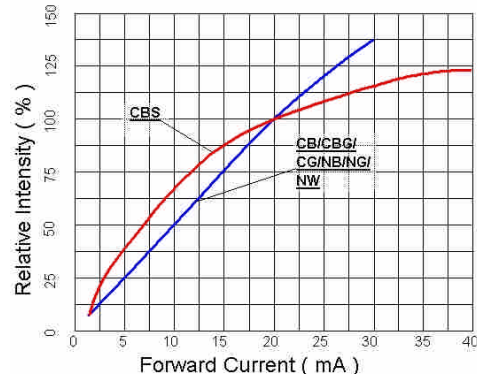
Forward Current vs. Ambient Temperature



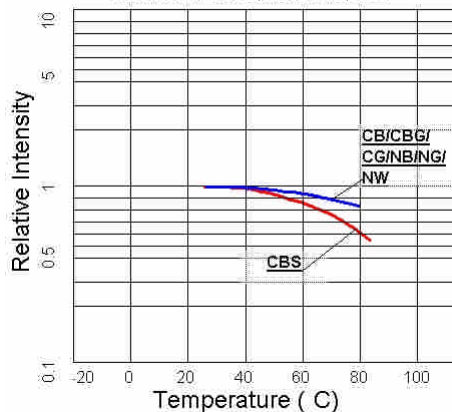
Forward Voltage vs. Forward Current



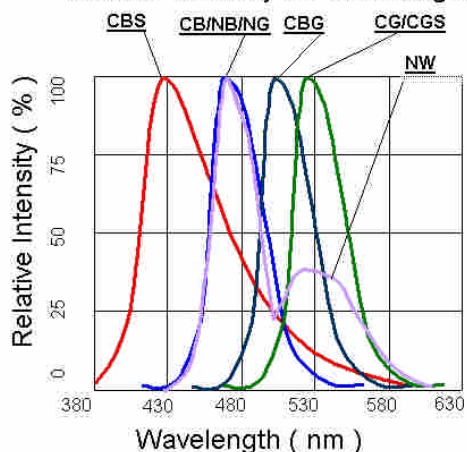
Relative Intensity vs. Forward Current



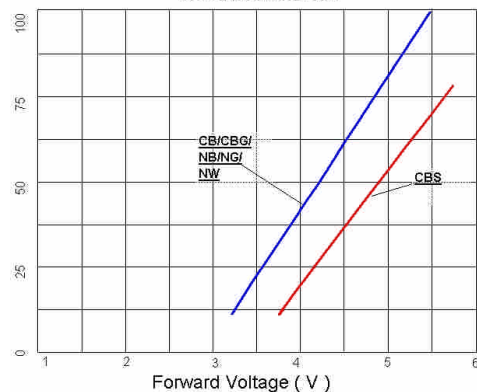
Relative Intensity vs. Ambient Temperature  
Pulsed 20mA; 300us pulse, 10ms period



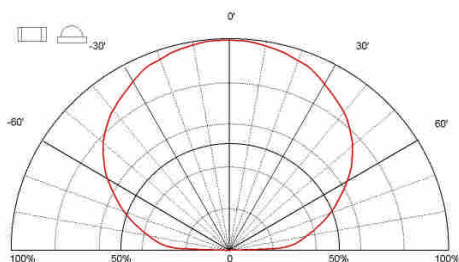
Relative Intensity vs. Wavelength



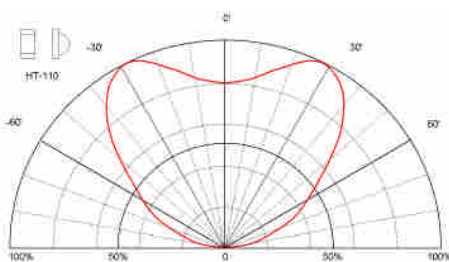
Peak Forward Voltage vs. Forward Current  
100's test pulse, 1% duty cycle



Directive Characteristics



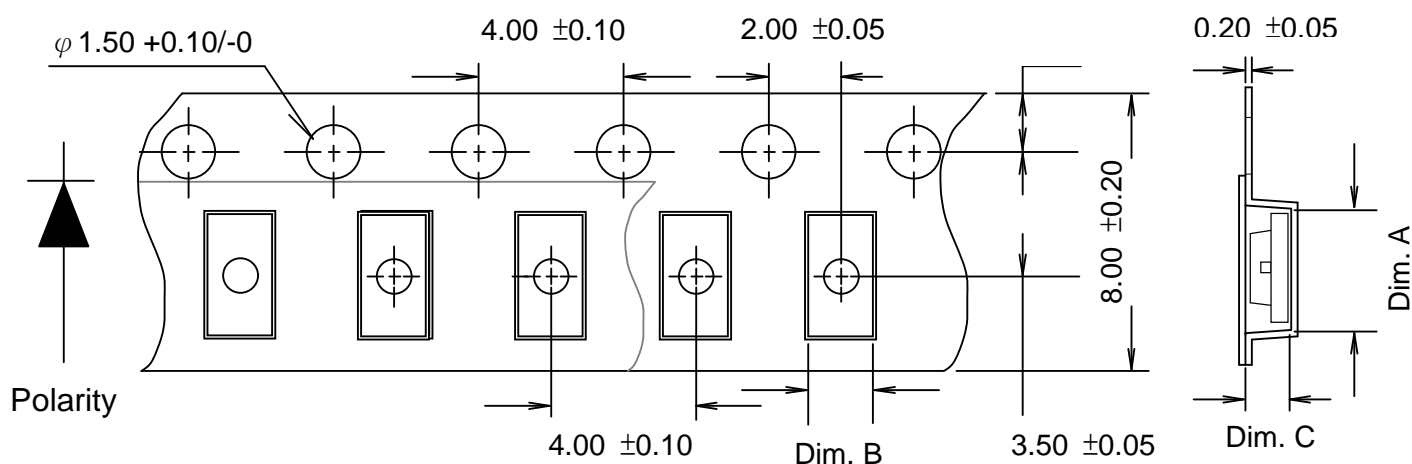
Directive Characteristics



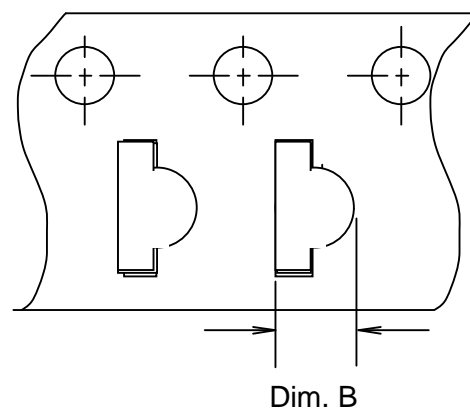
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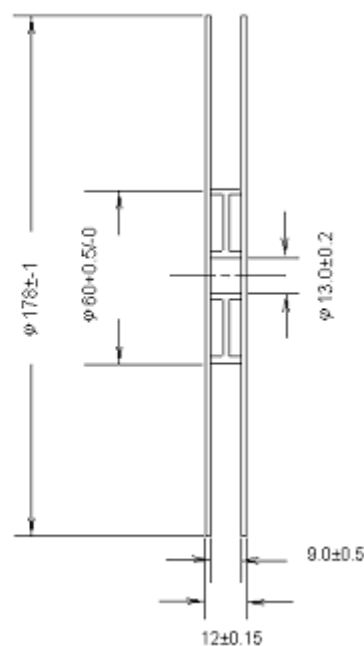
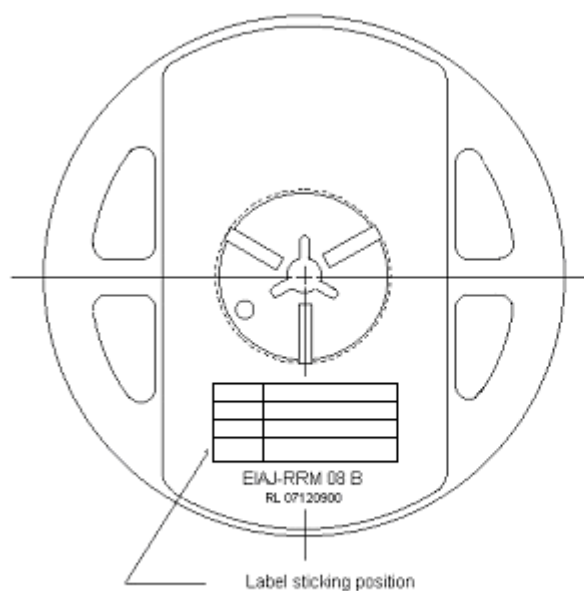
## Packaging Tape, Reel, and Packing Model Tape Dimension



Part No.	Dim. A	Dim. B	Dim. C	Q'ty/Reel
HT-110	$3.40 \pm 0.10$	$1.70 \pm 0.10$	$1.20 \pm 0.10$	3K

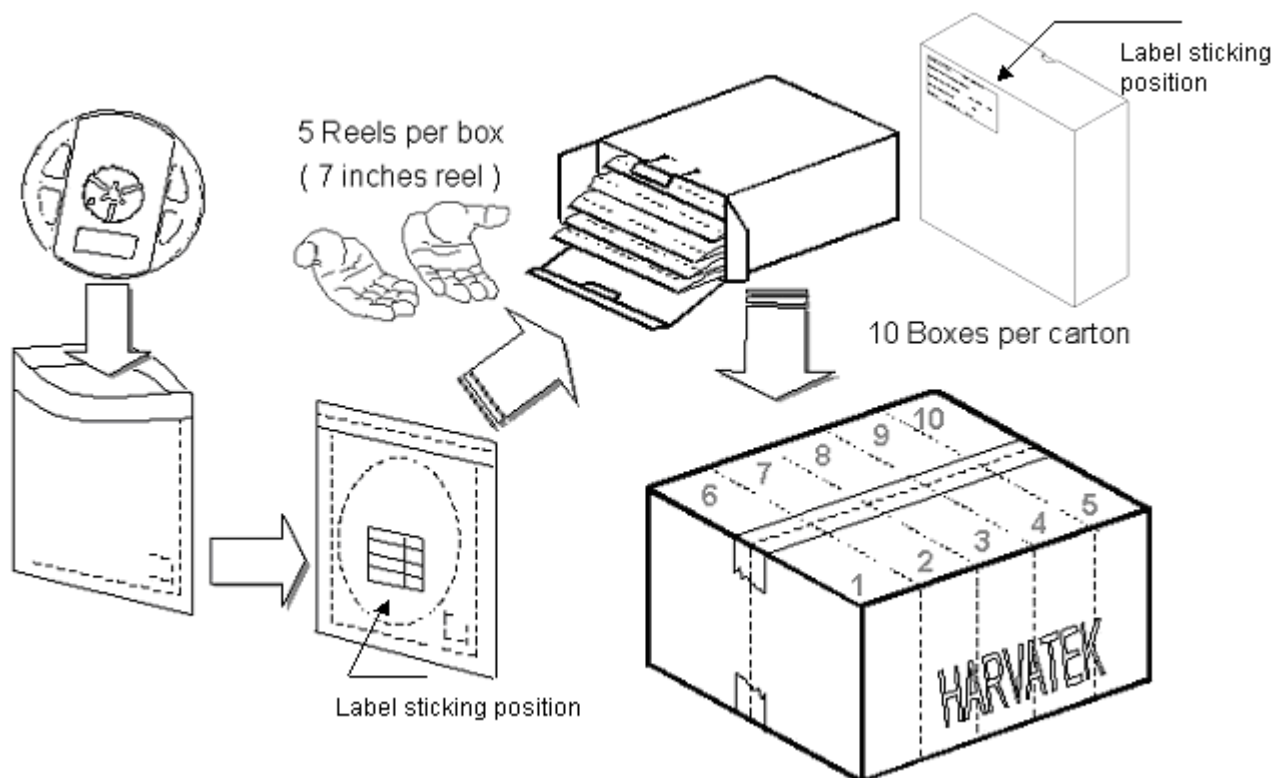


## Reel Dimension



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## Packing Model



5 boxes per carton is available according to shipping quantity.

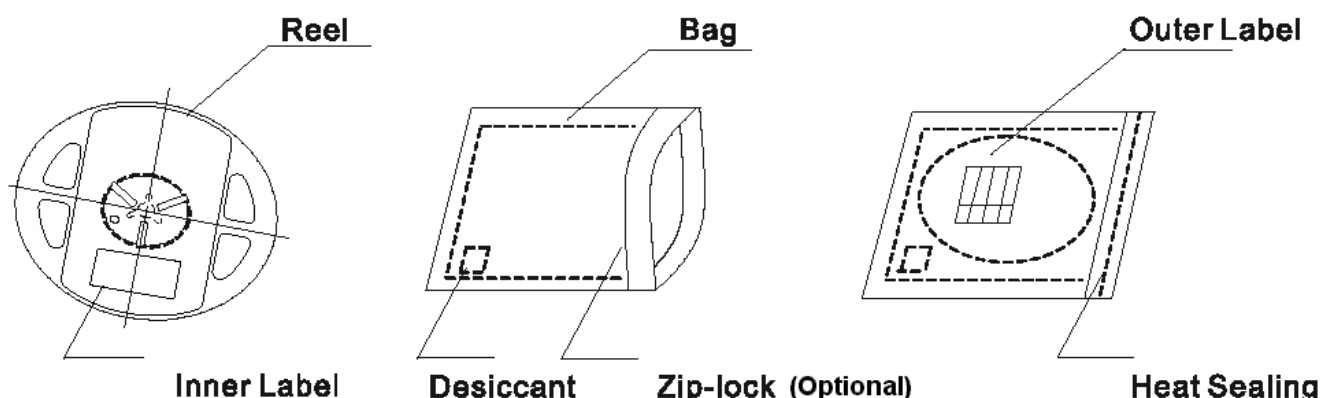
### Dry Pack

Any SMD optical device, like this chip LED, is **MOISTURE SENSITIVE device**. Avoid absorbing moisture at any time during transportation or storage. Every reel will be packaged in the moisture barrier anti-static bag (Specific bag material will depend upon customers' requirement or option). And the bag is well sealed before shipment.

By customer's requirement, we will put a humidity indicator in each moisture barrier anti-static bag before shipment.

The package is the following:

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## Cautions of Pick and Place

It should be avoided to load stress on the resin during high temperature.

Avoid rubbing or scraping the resin by any object.

Electric-static may cause damage to the component. Please confirm that the equipment grounding well. Using an ionizer fan is recommended.

## PRECAUTIONS

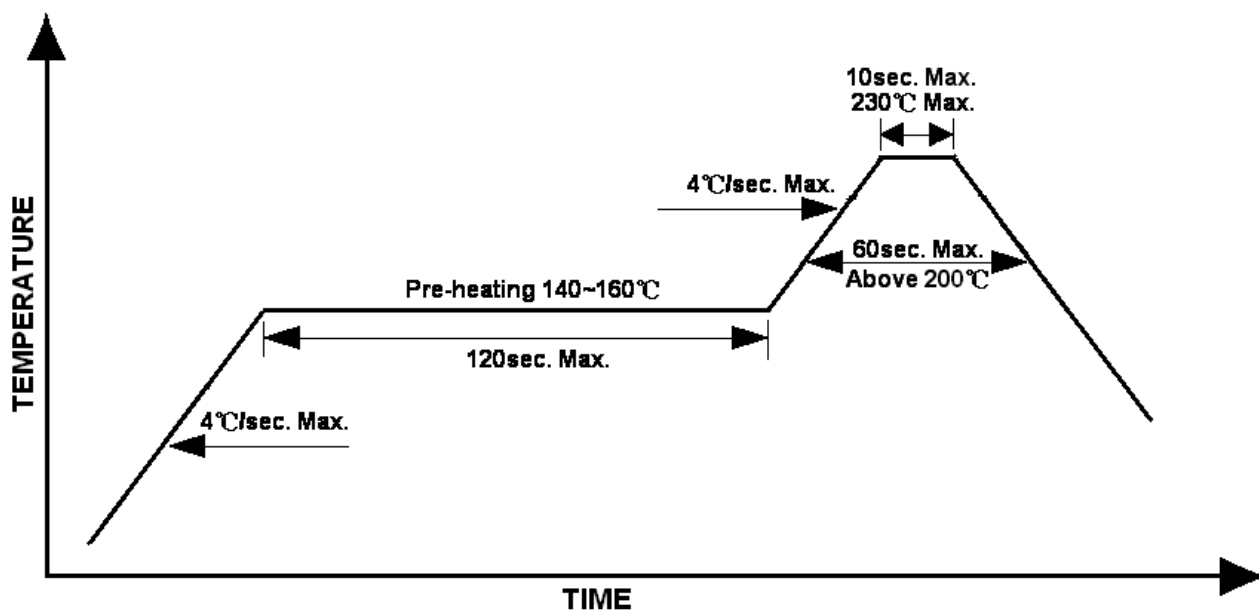
1. Avoid absorbing moisture at any time during transportation or storage.
2. Anti-Static process is needed especially when handling GaN, InGaN, and AlInGaP products.
3. It is suggested to connect the unit with a proper series current limit resistor. Avoid driving reverse voltage over the specification of LEDs when turning the unit ON/OFF.
4. Any application should refer to the specifications of absolute maximum ratings.
5. Avoid any direct contact with the viewing area.
6. If possible, assemble the unit in a clean room or dust-free environment.

## Reflow Soldering

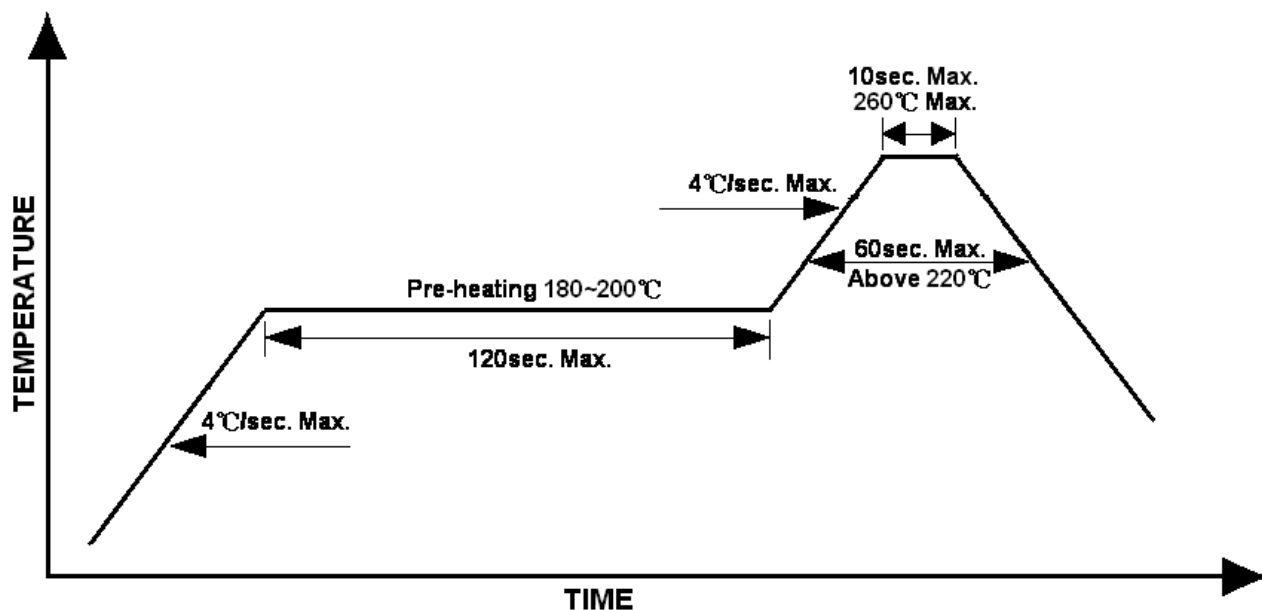
- ◆ Recommend tin glue specifications:  
Melting temperature: 178~192 °C
- ◆ Never take next process until the component is cooled down to room temperature after reflow.
- ◆ The recommended reflow soldering profile (measuring on the surface of the LED resin) is following:

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## Lead Solder



## Lead-free Solder



## Cleaning

The conditions of cleaning after soldering:

An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.

Temperature $\times$ Time:  $<50^{\circ}\text{C}\times 30\text{sec}$ , or  $<30^{\circ}\text{C}\times 3\text{min}$

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Ultra sonic cleaning: < 15W/ bath; Bath volume: 1liter max.

Curing: 100 °C max, <3min

Do not contact with component on the assembly board.

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